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Vishay Siliconix

# N-Channel 12 V (D-S) MOSFET



PRODUCT SUMMARY							
V <sub>DS</sub> (V)	12						
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.0027						
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 2.5 \text{ V}$	0.0032						
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 1.8 \text{ V}$	0.0040						
Q <sub>g</sub> typ. (nC)	33						
I <sub>D</sub> (A) <sup>a</sup>	34						
Configuration	Single						

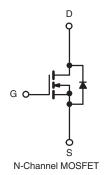
### **FEATURES**

- TrenchFET® power MOSFET
- 100 % R<sub>g</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



### **APPLICATIONS**

• Low V<sub>IN</sub> DC/DC



ORDERING INFORMATION				
Package	SO-8			
Lead (Pb)-free and halogen-free	Si4838BDY-T1-GE3			

ABSOLUTE MAXIMUM RATINGS	(1A = 25 °C, unless				
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage		$V_{DS}$	12	v	
Gate-source voltage		V <sub>GS</sub>	± 8		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		34		
	T <sub>C</sub> = 70 °C		27		
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	22.5 b, c		
	T <sub>A</sub> = 70 °C		18 <sup>b, c</sup>		
Pulsed drain current		I <sub>DM</sub>	70	A	
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		5.1		
	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2.2 b, c		
Single pulse avalanche current	. 0.1 11	I <sub>AS</sub>	20		
Avalanche energy	L = 0.1 mH	E <sub>AS</sub>	20	mJ	
Maximum power dissipation	T <sub>C</sub> = 25 °C		5.7	w	
	T <sub>C</sub> = 70 °C		3.6		
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 b, c		
	T <sub>A</sub> = 70 °C		1.6 <sup>b, c</sup>		
Operating junction and storage temperature ra	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b, d	t ≤ 10 s	$R_{thJA}$	39	50	°C/W	
Maximum junction-to-foot (drain)	Steady state	$R_{thJF}$	18	22	C/ VV	

### Notes

- a. Based on  $T_C = 25~^{\circ}C$
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. Maximum under steady state conditions is 85  $^{\circ}\text{C/W}$

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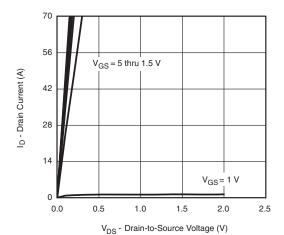
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	<u>l</u>			1		I.	
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	12	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	J 050 A	-	12	-	mV/°C	
V <sub>GS(th)</sub> temperature coefficient	ΔV <sub>GS(th)</sub> /T <sub>J</sub>	$I_D = 250  \mu A$	-	-3.2	-		
Gate-source threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250 \mu A$	0.4	-	1	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$	-	-	± 100	nA	
Zoro goto voltago drain ourrent	1	V <sub>DS</sub> = 12 V, V <sub>GS</sub> = 0 V -		-	1		
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS}$ = 12 V, $V_{GS}$ = 0 V, $T_J$ = 55 °C	-	-	10	μA	
On-state drain current a	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	30	-	-	Α	
		$V_{GS} = 4.5 \text{ V}, I_D = 15 \text{ A}$	-	0.0021	0.0027		
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 2.5 \text{ V}, I_D = 12 \text{ A}$	-	0.0025	0.0032	Ω	
		$V_{GS} = 1.8 \text{ V}, I_D = 10 \text{ A}$	-	0.0031	0.0040		
Forward transconductance a	g <sub>fs</sub>	$V_{DS} = 15 \text{ V}, I_D = 15 \text{ A}$	-	105	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>		-	5760	-	pF	
Output capacitance	Coss	$V_{DS} = 6 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	1730			
Reverse transfer capacitance	$C_{rss}$		-	1145			
Total gate charge	0	$V_{DS} = 6 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$	-	56	84	nC	
Total gate charge	$Q_g$		-	33	50		
Gate-source charge	$Q_{gs}$	$V_{DS} = 6 \text{ V}, V_{GS} = 2.5 \text{ V}, I_D = 10 \text{ A}$	-	5.9			
Gate-drain charge	$Q_{gd}$		-	12.5	-		
Gate resistance	$R_g$	f = 1 MHz	0.2	0.65	1.3	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	25	50		
Rise time	t <sub>r</sub>	$V_{DD} = 6 \text{ V}, R_L = 0.6 \Omega$	-	29	55		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	140	240		
Fall time	t <sub>f</sub>		-	35	65		
Turn-on delay time	t <sub>d(on)</sub>		-	12	24	ns	
Rise time	t <sub>r</sub>	$V_{DD} = 6 \text{ V}, R_L = 0.6 \Omega$	-	13	26		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 8 \text{ V}, R_g = 1 \Omega$	-	56	100		
Fall time	t <sub>f</sub>		-	10	20		
<b>Drain-Source Body Diode Characteristi</b>	cs						
Continuous source-drain diode current	Is	T <sub>C</sub> = 25 °C	-	-	5.1	۸	
Pulse diode forward current <sup>a</sup>	I <sub>SM</sub>		-	-	70	А	
Body diode voltage	$V_{SD}$	I <sub>S</sub> = 3 A	-	0.60	1.1	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	52	100	ns	
Body diode reverse recovery charge	$Q_{rr}$	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	40	80	nC	
Reverse recovery fall time	ta	$T_J = 25  ^{\circ}C$	-	21	-		
Reverse recovery rise time	t <sub>b</sub>		-	31	-	ns	

### Notes

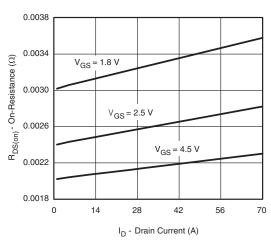
- a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

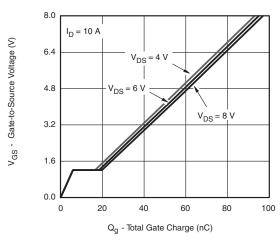




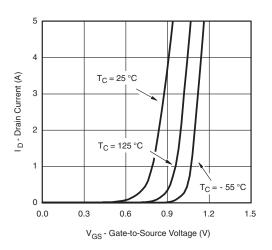
### **Output Characteristics**



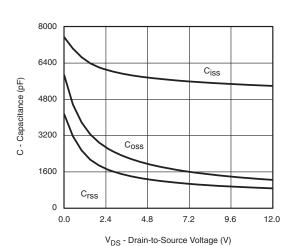
### On-Resistance vs. Drain Current and Gate Voltage



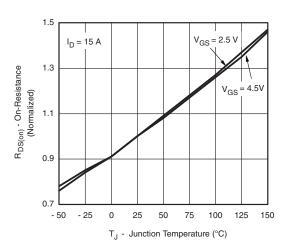
**Gate Charge** 



### **Transfer Characteristics**

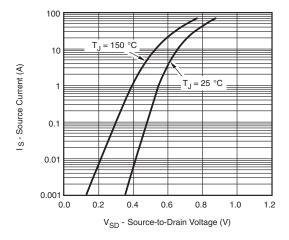


Capacitance

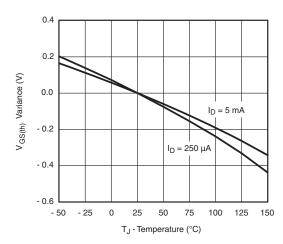


On-Resistance vs. Junction Temperature

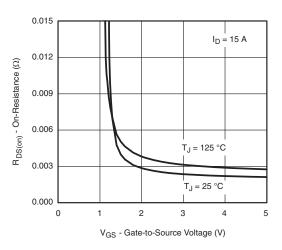




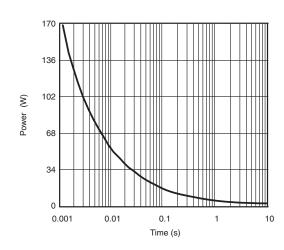
### Source-Drain Diode Forward Voltage



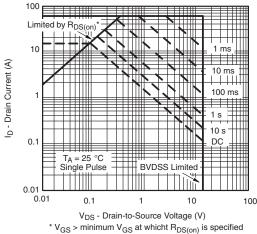
**Threshold Voltage** 

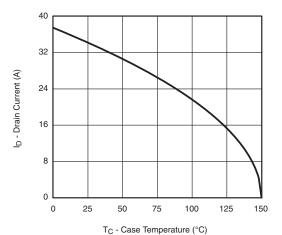


On-Resistance vs. Gate-to-Source Voltage

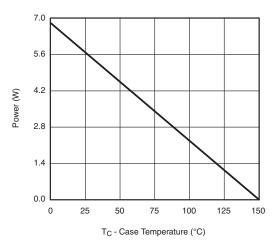


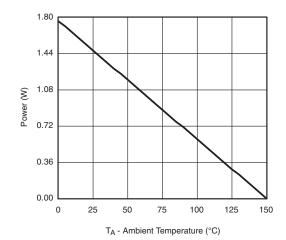
Single Pulse Power, Junction-to-Ambient





### Current Derating a





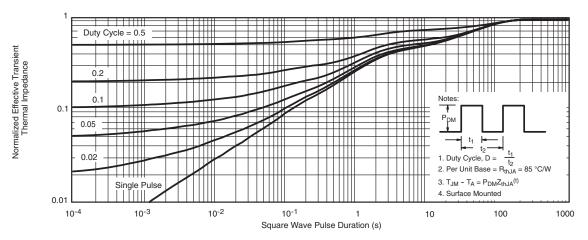
Power, Junction-to-Foot

Power, Junction-to-Ambient

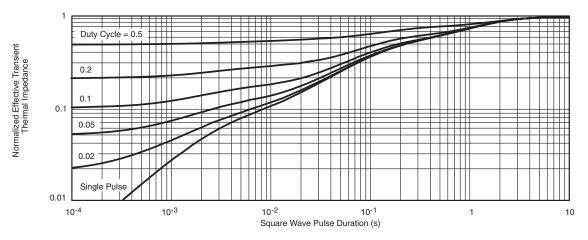
### Note

a. The power dissipation  $P_D$  is based on  $T_J$  max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

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# LON NOTE



### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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